Marking of Hazardous Substances 有害物质标识

According to the GB 26572-2025 Standard of the People's Republic of China for the Electronic Industry.

本表格依据中华人民共和国GB 26572-2025的规定编制。

Model 模型: S821A, S822A, S823A,C821A, C822A, C823A

Component Name 部件名称	Hazardous Substances 有害物质									
	Lead 铅 (Pb)	Mercury 汞 (Hg)	Cadmium 镉 (Cd)	Hexavalent Chromium 六价铬 (Cr (VI))	Polybrominated biphenyls 多溴联苯 (PBB)	Polybrominated diphenyl ethers 多溴二苯醚 (PBDE)	Bis(2-ethylhexyl) phthalate 和邻苯二甲酸二(2-乙基)己酯 (DEHP)	Butyl benzyl phthalate 邻苯二甲酸丁基苄酯 (BBP)	Dibutyl phthalate 邻苯二甲酸二正丁酯 (DBP)	Diisobutyl phthalate 邻苯二甲酸二异丁酯 (DIBP)
Connectors 连接器	X*	O	O	O	O	O	O	O	O	O

This table was developed according to the provisions of GB 26572-2025.
本表格依据GB 26572-2025的规定编制。

Note 1:

O: Indicates that the concentration of this hazardous substance in all homogeneous materials of this part is below the limit requirement of the national standard for restricting the use of hazardous substances in electrical and electronic products.
表示该有害物质在该部件所有均质材料中的含量均不超出电器电子产品有害物质限制使用国家标准要求。

X: Indicates that the concentration of this hazardous substance in at least one homogeneous material of this part exceeds the limit requirement of the national standard for restricting the use of hazardous substances in electrical and electronic products.
表示该有害物质至少在该部件的某一均质材料中的含量超出电器电子产品有害物质限制使用国家标准要求。

Note 2:

For components not listed above, it indicates that the concentration of their hazardous substances is below the limit requirement of the national standard for restricting the use of hazardous substances in electrical and electronic products.
以上未列出的部件,表明其有害物质含量均不超出电器电子产品有害物质限制使用国家标准要求。

* Exemption according to EU RoHS 2011/65 Annex III (6c) applies
Exemption according to "List of Exemptions for the Use of Restricted Substances under Compliance Management (2026 Edition)" (13) applies
* 符合欧盟RoHS指令2011/65/EU附录III中的豁免条款(6c)。
符合《电器电子产品有害物质限制使用合规管理目录(2026年版)》豁免条款(13)。

This statement is based on information and data provided by third parties and may not have been verified through destructive testing methods or other chemical analysis.
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